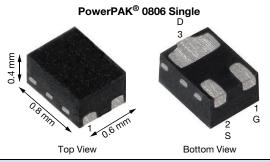
### SiUD412ED

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**Vishay Siliconix** 



12

0.34

0.4

0.55

1.2

2.5 0.47

0.5 a, f

Single

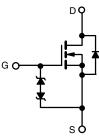
# N-Channel 12 V (D-S) MOSFET

### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- Ultra small 0.8 mm x 0.6 mm outline
- Ultra thin 0.4 mm max. height
- Typical ESD protection 1500 V (HBM)
- 1.2 V rated R<sub>DS(on)</sub>
- 100 % R<sub>a</sub> tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### APPLICATIONS

- Load switch
- · High speed switching
- DC/DC converters
- · Battery-operated and mobile devices



N-Channel MOSFET

### ORDERING INFORMATION

**PRODUCT SUMMARY** 

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 4.5 V

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS} = 2.5$  V

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 1.8 V

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 1.5 V

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 1.2 V

Package	PowerPAK 0806			
Lead (Pb)-free and halogen-free	SiUD412ED-T1-GE3			

Note

V<sub>DS</sub> (V)

Qg typ. (nC)

Configuration

I<sub>D</sub> (A)

The lead finish is NiPdAu and classed as E4 finish

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	s 12		
Gate-source voltage		V <sub>GS</sub>	± 5	V	
	T <sub>A</sub> = 25 °C		0.5 <sup>a, f</sup>		
Continuous ducia compaty (T. 150 °C)	T <sub>A</sub> = 70 °C		0.5 <sup>a, f</sup>		
Continuous drain current $/T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	0.5 <sup>b</sup>		
	T <sub>A</sub> = 70 °C	1	0.5 <sup>b</sup>	A	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	1.5		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C		0.5 <sup>a, f</sup>		
	T <sub>A</sub> = 70 °C	I <sub>S</sub>	0.37 <sup>b</sup>		
Maximum power dissipation	T <sub>A</sub> = 25 °C		1.25 ª		
	T <sub>A</sub> = 70 °C		0.8 <sup>a</sup>	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.37 <sup>b</sup>	vv	
	T <sub>A</sub> = 70 °C	1	0.24 <sup>b</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature) <sup>c</sup>			260	-0	

THERMAL RESISTANCE RATINGS							
	SYMBOL	TYPICAL	MAXIMUM	UNIT			
t ≤ 5 s	R <sub>thJA</sub>	80	100	°C/W			
t ≤ 5 s	R <sub>thJA</sub>	265	335	C/W			
	t ≤ 5 s	SYMBOL   t ≤ 5 s R <sub>thJA</sub>	SYMBOL TYPICAL   t ≤ 5 s R <sub>thJA</sub> 80	SYMBOL TYPICAL MAXIMUM   t ≤ 5 s R <sub>thJA</sub> 80 100			

#### Notes

а.

Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s Surface mounted on 1" x 1" FR4 board with minimum copper, t = 5 s b.

Refer to IPC / JEDEC<sup>®</sup> (J-STD-020), no manual or hand soldering Maximum under steady state conditions is 135 °C/W Maximum under steady state conditions is 400 °C/W C.

d.

e. f. Package limited

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# SiUD412ED

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PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Static			•	•	•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	12	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 ··· A	-	9	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-1	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.35	-	0.9	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$	-	-	± 10		
Zere gete veltege drein eurrent		$V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA	
Zero gate voltage drain current	IDSS	$V_{DS} = 12 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \! \geq \! 5$ V, $V_{GS}$ = 4.5 V	1	-	-	Α	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	0.27	0.34		
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 0.2 \text{ A}$	-	0.31	0.4		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 0.1 \text{ A}$	-	0.37	0.55	Ω	
		$V_{GS} = 1.5 \text{ V}, \text{ I}_{D} = 0.1 \text{ A}$	-	0.42	1.2		
		$V_{GS} = 1.2 \text{ V}, \text{ I}_{D} = 0.05 \text{ A}$	-	0.55	2.5		
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 6 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	1.6	-	S	
Dynamic <sup>b</sup>				•		•	
Input capacitance	C <sub>iss</sub>		-	21	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS}$ = 6 V, $V_{GS}$ = 0 V, f = 1 MHz	-	13	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	7	-		
Total gate charge	Qg	$V_{DS} = 6 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	0.47	0.71		
Gate-source charge	Q <sub>gs</sub>		-	0.04	-	nC	
Gate-drain charge	Q <sub>gd</sub>	$V_{DS} = 6 V, V_{GS} = 4.5 V, I_D = 0.5 A$	-	0.09	-		
Gate resistance	Rg	f = 1 MHz	3	15	30	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	2	5		
Rise time	tr	$V_{DD}$ = 6 V, $R_L$ = 12 $\Omega$ , $I_D \cong 0.5$ A,	-	20	40	ns	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	-	17	35		
Fall time	t <sub>f</sub>		-	10	20		
Drain-Source Body Diode Characterist	ics			•		•	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>A</sub> = 25 °C	-	-	0.5 <sup>c</sup>		
Pulse diode forward current	I <sub>SM</sub>		-	-	1.5	A	
Body diode voltage	V <sub>SD</sub>	$I_{\rm S} = 0.5$ A, $V_{\rm GS} = 0$ V	-	0.7	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	15	30	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 0.5 A, di/dt = 100 A/μs,	-	3	6	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25 \text{ °C}$	-	12.5	-		
Reverse recovery rise time	t <sub>b</sub>		-	2.5	-	ns	

Notes

a. Pulse test; pulse width  $\leq 300~\mu\text{s},$  duty cycle  $\leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

c. Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

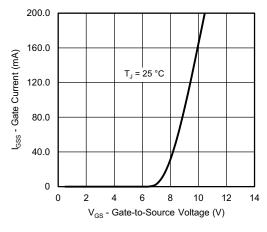
2



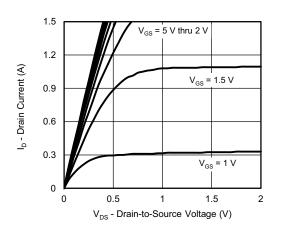
# SiUD412ED

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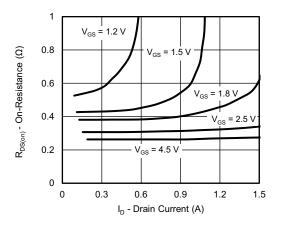
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



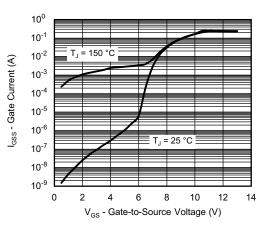
Gate-Current vs. Gate-Source Voltage



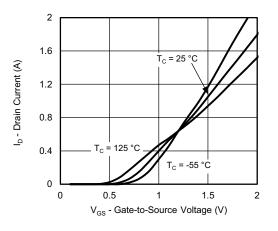
**Output Characteristics** 



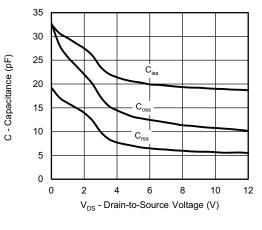
On-Resistance vs. Drain Current and Gate Voltage



Gate-Current vs. Gate-Source Voltage



**Transfer Characteristics** 



Capacitance

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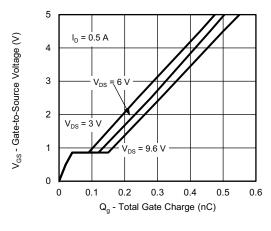
3

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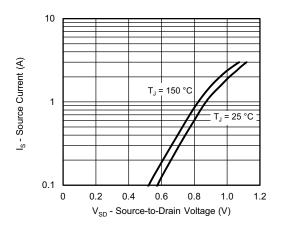
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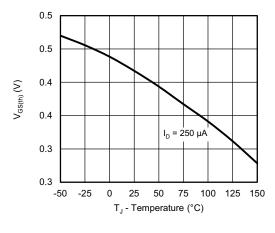
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



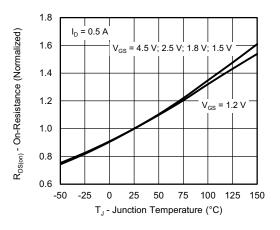
Gate Charge



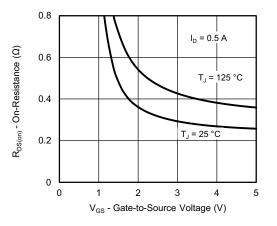
Source-Drain Diode Forward Voltage



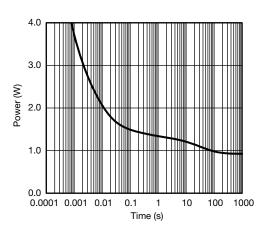
**Threshold Voltage** 



**On-Resistance vs. Junction Temperature** 



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

4

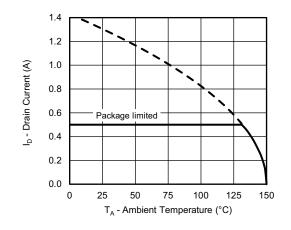
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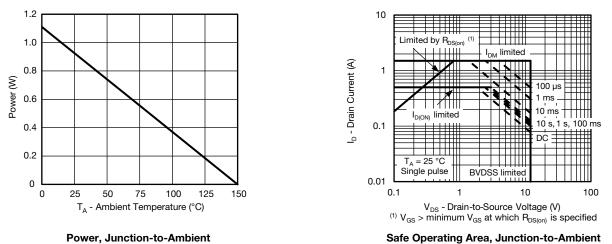
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating <sup>a</sup>



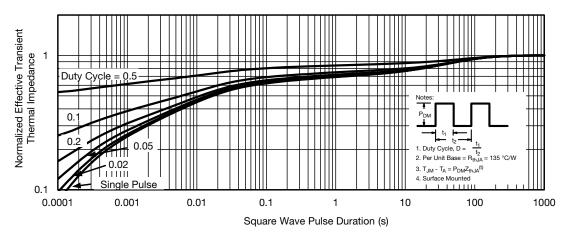
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package limit

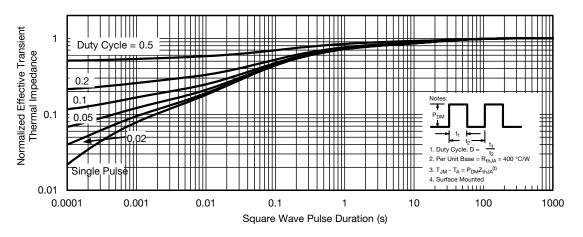
Note a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 25 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient (on 1" x 1" FR4 board with maximum copper)

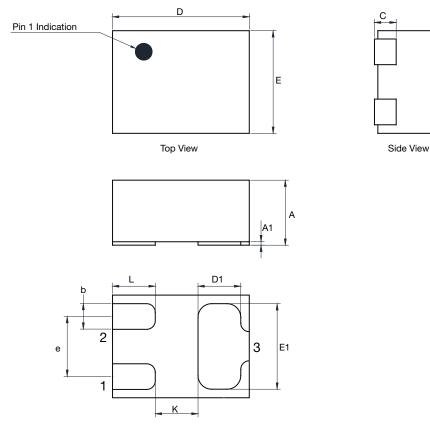


Normalized Thermal Transient Impedance, Junction-to-Ambient (on 1" x 1" FR4 board with minimum copper)

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## Case Outline for PowerPAK 0.8 mm x 0.6 mm



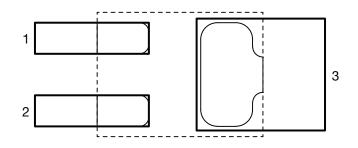
Bottom View

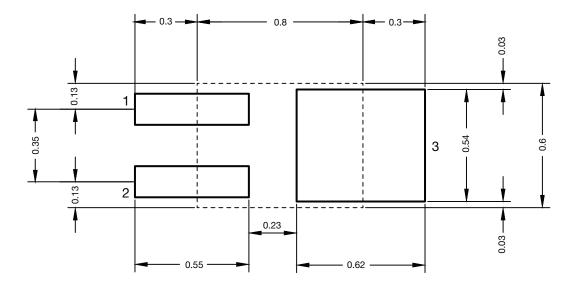
	MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.350	0.380	0.400	0.0138	0.0150	0.0157
A1	0	-	0.020	0	-	0.0008
b	0.120	0.150	0.180	0.0047	0.0059	0.0071
С	0.119	0.127	0.135	0.0047	0.0050	0.0053
D	0.750	0.800	0.850	0.0295	0.0315	0.0335
D1	0.200	0.250	0.300	0.0078	0.0098	0.0118
E	0.550	0.600	0.650	0.0217	0.0236	0.0256
E1	0.450	0.500	0.550	0.0177	0.0197	0.0217
е	0.300	0.350	0.400	0.0118	0.0138	0.0158
К	0.150	0.250	0.350	0.0058	0.0098	0.0138
L	0.200	0.250	0.300	0.0078	0.0098	0.0118
ECN: C13-1574-R DWG: 6020	ev. A, 23-Dec-13	•			•	·





# **Recommended Land Pattern PowerPAK® 0806**







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